

DATA SHEET

AUTOMOTIVE GRADE SURGE CHIP RESISTORS (LEAD FREE)

SR_P series 0.5%, 1%, 5%, 10%, 20% sizes 0201/0402/0603/0805/1206



YAGEO



SCOPE

This specification describes SR0201 to SR1206 chip resistors made by thick film process.

APPLICATIONS

- Total lead free without RoHS exemption
- Telecommunications
- Power supplies
- Car electronics

FEATURES

- AEC-Q200 qualified
- Superior to RC series in pulse withstanding voltage and surge withstanding voltage.
- MSL class: MSL I
- Halogen free epoxy
- Reduce environmentally hazardous waste
- High component and equipment reliability

ORDERING INFORMATION - GLOBAL PART NUMBER

Part number is identified by the series name, size, tolerance, packaging type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

SR XXXX X X X XX XXXX P (2) (3) (4) (5) (6) (7) (I)

(I) SIZE

0201/0402/0603/0805/1206

(2) TOLERANCE

 $D = \pm 0.5\%$

 $F = \pm 1\%$

 $1 = \pm 5\%$

 $K = \pm 10\%$

 $M = \pm 20\%$

(3) PACKAGING TYPE

R = Paper taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Based on spec.

(5) TAPING REEL & POWER

07 = 7 inch dia, Reel 7W = 7 inch dia. Reel & 2 x standard power

7T = 7 inch dia. Reel & 3 x standard power

47 = 7 inch dia. Reel & $4 \times$ standard power

(6) RESISTANCE VALUE

 $|\Omega \le R \le |M\Omega|$

There are 2~4 digits indicated the resistance value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed coding rules of resistance are shown in the table of "Resistance rule of global part number".

(7) DEFAULT CODE

Letter P is lead free (without RoHS exemption).

Resistance rule of number	of global part
Resistance coding rule	Example
XRXX (1 to 9,76 Ω)	IR = I Ω IR5 = I.5 Ω 9R76 = 9.76 Ω
XXRX (10 to 97.6 Ω)	$10R = 10 \Omega$ $97R6 = 97.6 \Omega$
XXXR (100 to 976 Ω)	100R = 100 Ω
XKXX (Ι to 9.76 Κ Ω)	$1K = 1,000 \Omega$ $9K76 = 9760 \Omega$
XXKX (10 to 97.6 K Ω)	$10K = 10,000 \Omega$ $97K6 = 97,600 \Omega$
XXXK (100 KΩ)	100Κ = 100,000 Ω

ORDERING EXAMPLE

The ordering code for an SR0805 chip resistor, value $10 \text{ K}\Omega$ with ±5% tolerance, supplied in 7-inch tape reel is: SR0805JR-0710KP.

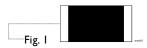


Chip Resistor Surface Mount

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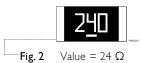
<u>MARKING</u>

SR0201/0402

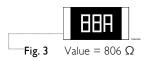


No Marking

SR0603



1%, 0.5%,E24 exception values 10/11/13/15/20/75 of E24 series



1%, 0.5%, E96 refer to EIA-96 marking method, including values 10/11/13/15/20/75 of E24 series

SR0805 /1206



Both E-24 and E-96 series: 4 digits, \pm 0.5% & \pm 1%

First three digits for significant figure and 4th digit for number of zeros

NOTE

For further marking information, please refer to data sheet "Chip resistors marking".

TAPING REEL & POWER

Table I

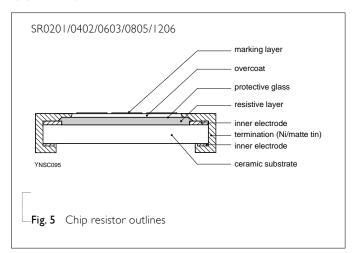
		PC	OWER, W (P70)		
TYPE			CODING		
	07	7W	7 T	47	
0201	1/20	1/10	-	1/5	
0402	1/16	1/8	1/5	-	
0603	1/10	1/5	1/4	-	
0805	1/8	1/4	1/3	1/2	
1206	1/4	1/2	3/4	-	



CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive glaze. The resistive glaze is covered by a lead-free glass. The composition of the glaze is adjusted to give the approximately required resistance value. The whole element is covered by a protective overcoat. The top of overcoat is marked with the resistance value. Finally, the two external terminations (Ni/matte tin) are added, as shown in Fig. 5.

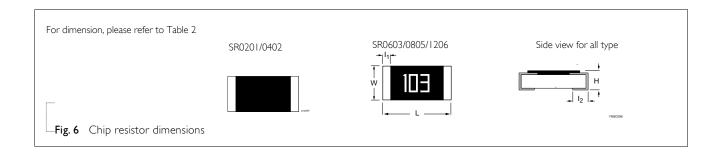
OUTLINES



<u>DIMENSIONS</u>

Table 2

TYPE	L (mm)	W (mm)	H (mm)	I ₁ (mm)	I ₂ (mm)
SR0201	0.60±0.03	0.30±0.03	0.23±0.03	0.12±0.05	0.15±0.05
SR0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
SR0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
SR0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
SR1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.45±0.20





ELECTRICAL CHARACTERISTICS

Table 3

					CHARAC	TERISTICS	
TYPE	POWER	resistance range	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
•	1/20W						$ \Omega \le R \le 0\Omega $
SR0201	1/10W			25V	50V	50V	-100~+350ppm°C 10Ω < R ≤ IMΩ
	1/5W		-				± 200 ppm°C
	I/I6W_						
SR0402	1/8W			75V	100V	100V	
	1/5W	E24 5%, 10%, 20% $I\Omega \leq R \leq IM\Omega$ E24/E96 0.5%, 1% $I\Omega \leq R \leq IM\Omega$					
	1/10W						
SR0603	1/5W			75V	150V	150V	
	1/4W		–55 °C to +155 °C _				$1\Omega \le R \le 10\Omega$
	1/8W		_				± 200 ppm°C
SR0805	1/4W			150//	2001	2001/	$10\Omega < R \le 1M\Omega$ ± 100 ppm°C
3KU8U3	1/3W			150V	300V	300V	± 100 ppm C
	1/2W						
	1/4W						
SR1206	1/2W			200 V	400 V	500V	
	3/4W						

FOOTPRINT AND SOLDERING PROFILES

Recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

 Table 4
 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	SR0201/0402	SR0603/0805/1206
Paper taping reel (R)	7" (178 mm)	10,000	5,000

NOTE

1. For paper/embossed tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

Range: -55 °C to +155 °C

POWER RATING

Each type rated power at 70 °C: SR0201: I/20W, I/10W, I/5W SR0402: I/16W, I/8W, I/5W SR0603: I/10W, I/5W, I/4W SR0805: I/8W, I/4W, I/3W, I/2W SR1206: I/4W, I/2W, 3/4W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

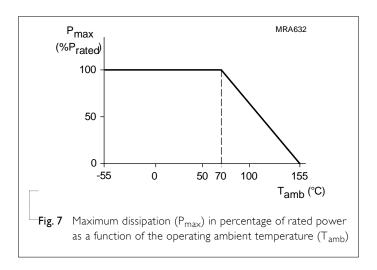
or max. working voltage whichever is less

Where

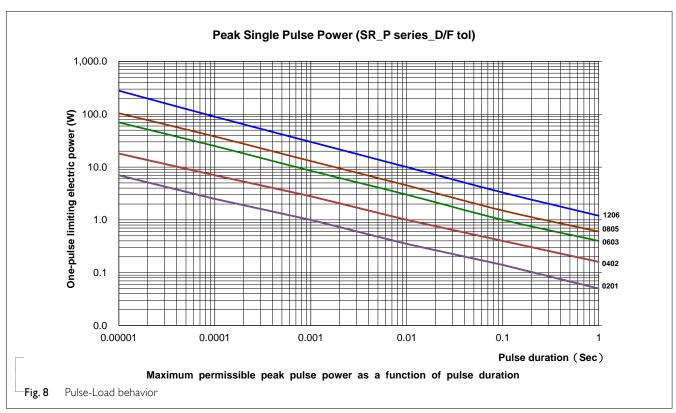
V = Continuous rated DC or AC (rms) working voltage (V)

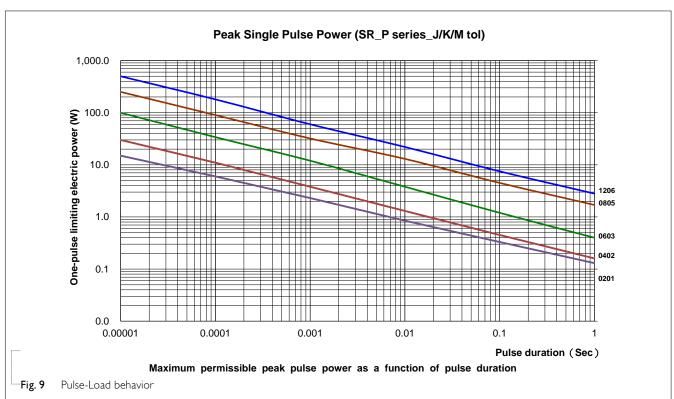
P = Rated power (W)

 $R = Resistance value (\Omega)$



PULSE LOAD BEHAVIOR









TESTS AND REQUIREMENTS

Table 5 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
High Temperature Exposure	AEC-Q200 Test 3 MIL-STD-202 Method 108	1,000 hours at T_A = 155 °C, unpowered	$\pm(2.0\% + 0.05\Omega)$ for D/F tol $\pm(3.0\% + 0.05\Omega)$ for others
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for I 0d. with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	$\pm (0.5\% + 0.05\Omega)$ for D/F tol $\pm (2.0\% + 0.05\Omega)$ for others
Biased Humidity	AEC-Q200 Test 7 MIL-STD-202 Method 103	I,000 hours; 85 °C / 85% RH I 0% of operating power Measurement at 24±4 hours after test conclusion.	$\pm (1.0\% + 0.05 \Omega)$ for D/F tol $\pm (3.0\% + 0.05 \Omega)$ for others
Operational Life	AEC-Q200 Test 8 MIL-STD-202 Method 108	1,000 hours at 125 °C, derated voltage applied for 1.5 hours on, 0.5 hour off, still-air required	$\pm (2.0\% + 0.05\Omega)$ for D/F tol $\pm (3.0\% + 0.05\Omega)$ for others
Resistance to Soldering Heat	AEC-Q200 Test 15 MIL-STD-202 Method 210	Condition B, no pre-heat of samples Lead-free solder, 260±5 °C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(1.0%+0.05Ω) No visible damage
Thermal Shock	MIL-STD-202 Method 107	-55/+125 °C Number of cycles is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	$\pm (0.5\% + 0.05\Omega)$ for D/F tol $\pm (1.0\% + 0.05\Omega)$ for others
ESD	AEC-Q200 Test 17 AEC-Q200-002	Human Body Model, I pos. + I neg. discharges 0201: 500V 0402/0603: IKV 0805 and above: 2KV	±(3.0%+0.05Ω)
Solderability - Wetting	AEC-Q200 Test 18 J-STD-002	Electrical Test not required Magnification 50X SMD conditions: (a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds. (b) Method B, steam aging 8 hours, dipping at 215±3 °C for 5±0.5 seconds.	Well tinned (≥95% covered) No visible damage





Chip Resistor Surface Mount | SR_P | SERIES | 0201/0402/0603/0805/1206

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Board Flex	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 100mm x 40mm glass epoxy resin PCB (FR4) Bending for 0201/0402: 5 mm 0603/0805: 3 mm 1206 and above: 2 mm Holding time: minimum 60 seconds	±(1.0%+0.05Ω)
Temperature Coefficient of Resistance (T.C.R.)	MIL-STD-202 Method 304	At +25/–55 °C and +25/+125 °C Formula: T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$ Where t_1 =+25 °C or specified room temperature t_2 =-55 °C or +125 °C test temperature R_1 =resistance at reference temperature in ohms R_2 =resistance at test temperature in ohms	Refer to table 2
Short Time Overload	IEC60115-1 8.1	2.5 times of rated voltage or maximum $\pm (2.0\% \pm 0.05 \Omega)$ overload voltage whichever is less for 5 sec at room temperature	





Chip Resistor Surface Mount SR_P SERIES 0201/0402/0603/0805/1206

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version I	Jan. 20, 2022	-	- Add size 0201
Version 0	Feb. 03, 2021	-	- New product datasheet



SERIES

0201/0402/0603/0805/1206

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